

**In the Specification:**

At page 12, replace the second paragraph with the following:

In still another embodiment of the invention, the plug 10 and the adhesive compound may form complementary parts of a two-part bonding system. With reference still to Figures 1 through 6, the plug 10 may be comprised of a ~~base~~ first component of the two-part system, while a relatively low viscosity ~~catalyst~~ second component that activates the bonding properties of the ~~base~~ first component is applied to the wall 28 of the root canal 26. Since the bond between the plug 10 and the root canal surfaces is formed without the use of a light-curing bonding compound, it is not necessary to expose the plug 10 to a light source, as shown in Figures 3 and 5. For example, the first component may comprise a base component of the two part system, while the second portion comprises a catalyst portion. The first component may also comprise an activator that activates the bonding properties of the second component. In addition, a "dual cure" adhesive system that contains a photocatalyst to aid curing may also be used that would permit the plug 10 and the adhesive to cure chemically and by exposure to light. Although the "dual cure" system contains the photocatalyst, it is understood that the photocatalyst is included in the "dual cure" system to accelerate the curing process. Accordingly, the "dual cure" system will cure even in the absence of exposure to light, but the curing occurs at a slower rate. Accordingly, the "dual cure" system advantageously permits the plug 10 to bond to the root canal surfaces in cases where the light fails to reach all portions of the interface between the plug 10 and the root canal surfaces, or in cases where the light curing step is omitted entirely.